

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









## **Features**

- RoHS compliant\*
- Leadless 0603 (1608) chip
- High speed switching

# **Applications**

- Cellular phones
- PDAs
- Desktop PCs and notebooks
- Digital cameras
- MP3 players

# CD0603-S01575 Switching Chip Diode

#### **General Information**

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components.

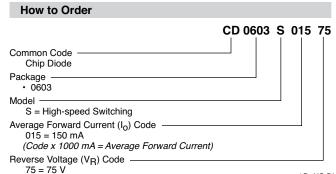
Bourns offers small-signal high-speed Switching Diodes for switching digital signal applications, in compact chip package 0603 size format, which offers PCB real estate savings and are considerably smaller than competitive parts. The Switching Diodes offer a Repetitive Peak Forward Current of 200 mA and a reverse voltage of 75 V. The diodes are RoHS compliant and are compatible with lead-free manufacturing processes, conforming to many industry and government regulations on lead-free components. Bourns® Chip Diodes conform to JEDEC standards, are easy to handle on standard pick and place equipment and their flat configuration minimizes roll away.

#### Absolute Maximum Ratings (@ T<sub>A</sub> = 25 °C Unless Otherwise Noted)

Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	100	V
Reverse Voltage	V <sub>R</sub>	80	V
Average Forward Current	I <sub>F(AV)</sub>	100	mA
Repetitive Peak Forward Current	I <sub>FRM</sub>	225	mA
Non-repetitive Surge Forward Current @t < 1 s @t < 8.3 ms	IFSM	400 800	mA
Power Dissipation	P <sub>D</sub>	150	mW
Thermal Resistance Junction to Ambient Air	R <sub>OJA</sub>	375	°C/W
Storage Temperature	T <sub>STG</sub>	-55 to +150	°C
Operating Temperature	TJ	-55 to +150	°C

## Electrical Characteristics (@ T<sub>A</sub> = 25 °C Unless Otherwise Noted)

Parameter	Symbol	Value	Unit
Forward Voltage (Max.)	V <sub>F</sub>	1.00 (I <sub>f</sub> = 50 mA) 1.20 (I <sub>f</sub> = 100 mA)	V
Capacitance Between Terminals (Max.)	C <sub>T</sub>	3 (V <sub>r</sub> = 1 V, f = 1 MHz)	pF
Reverse Recovery Time (Max.)	t <sub>rr</sub>	$(I_F = I_R = 10 \text{ mA}, R_L = 50 \text{ ohms})$	nS
Reverse Current (Max.)	I <sub>R</sub>	2.5 (V <sub>R</sub> = 70 V)	μΑ



# **BOURNS**®

Asia-Pacific: Tel: +886-2 2562-4117 • Fax: +886-2 2562-4116

EMEA: Tel: +36 88 520 390 • Fax: +36 88 520 211

**The Americas:** Tel: +1-951 781-5500 • Fax: +1-951 781-5700

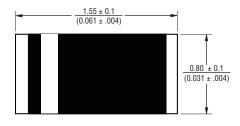
www.bourns.com

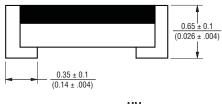
\*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011. Specifications are subject to change without notice.

# CD0603-S01575 Switching Chip Diode

# **BOURNS**®

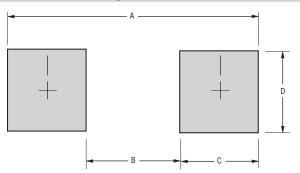
#### **Product Dimensions**





DIMENSIONS:  $\frac{MM}{(INCHES)}$ 

#### **Recommended Pad Layout**



Dimensions			
А	1.8 - 2.6		
	(0.075 - 0.102)		
В	0.8 (0.031)		
С	0.5 - 0.9 (0.020 - 0.035)		
D	0.8 - 1.0 (0.031 - 0.039)		

DIMENSIONS:  $\frac{MM}{(INCHES)}$ 

Users should verify actual device performance in their specific applications.

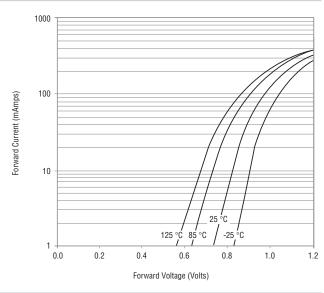
# **Physical Specifications**

Case	0603 (1608) Molded plastic
Terminals	Solder plated, solderable per MIL-STD-750,
	Method 2026
Polarity	Indicated by cathode band
Mounting Position	Any

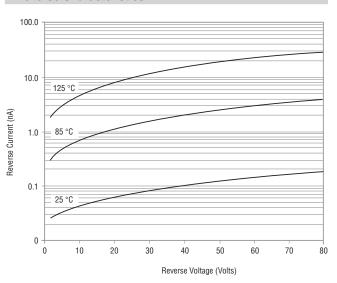
# CD0603-S01575 Switching Chip Diode

## Rating and Characteristic Curves: CD0603-S01575

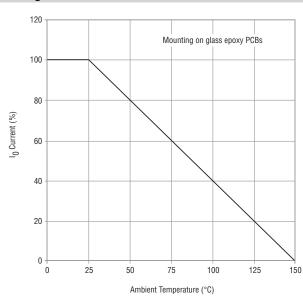
## **Forward Characteristics**



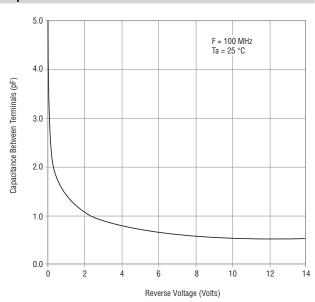
## **Reverse Characteristics**



## **Derating Curve**



## **Capacitance Between Terminals**

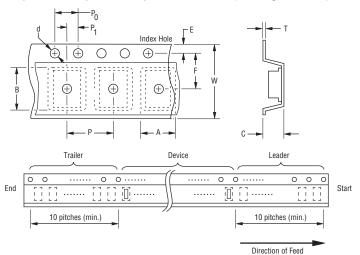


# CD0603-S01575 Switching Chip Diode

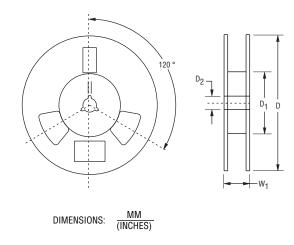
# BOURNS

## **Packaging Information**

The product is dispensed in tape and reel format (see diagram below).



Item	Symbol	0603
Carrier Width	А	$\frac{1.00 \pm 0.10}{(0.039 \pm 0.004)}$
Carrier Length	В	$\frac{1.70 \pm 0.10}{(0.067 \pm 0.004)}$
Carrier Depth	С	$\frac{1.00 \pm 0.10}{(0.039 \pm 0.004)}$
Sprocket Hole	d	$\frac{1.55 \pm 0.10}{(0.061 \pm 0.004)}$
Reel Outside Diameter	D	<u>178</u> (7.008)
Reel Inner Diameter	D <sub>1</sub>	60.0 (2.362) MIN.
Feed Hole Diameter	D <sub>2</sub>	$\frac{13.0 \pm 0.20}{(0.512 \pm 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$
Punch Hole Position	F	$\frac{3.50 \pm 0.05}{(0.138 \pm 0.002)}$
Punch Hole Pitch	Р	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Sprocket Hole Pitch	P <sub>0</sub>	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Embossment Center	P <sub>1</sub>	$\frac{2.00 \pm 0.05}{(0.079 \pm 0.002)}$
Overall Tape Thickness	Т	$\frac{0.20 \pm 0.05}{(0.008 \pm 0.002)}$
Tape Width	W	$\frac{8.00 \pm 0.20}{(0.315 \pm 0.008)}$
Reel Width	W <sub>1</sub>	13.5 (0.531) MAX.
Quantity per Reel		5,000



Devices are packed in accordance with EIA-481 standard and specifications shown here.

REV. 02/15